

MediaTek Inc.

ITEM :

## CRYSTAL OSCILLATOR

TYPE :

DSB221SDN

NOMINAL FREQUENCY :

26.000MHz

SPEC No. :

1XXB26000MAA

Please acknowledge receipt of this specification by signing and returning a copy to us.

	RECEIPT
DATE	
RECEIVED	(signature) (name)

General Manufacturer of Quartz Devices



675–0194 Japan Phone (81)79–425–3141 Fax (81)79–425–1134 http://www.kds.info/index\_en.htm

A. Hishikawa C.ENG. H. Takase ENG.

- 1. Device Name
- 2. Model Name DSB221SDN

TCXO

3. Nominal Frequency 26.000 MHz

4. Mass 0.02g max.

5. Absolute Maximum Ratings

	Item	Symbol		Rating		unit
1	Supply Voltage	Vcc		-0.3~+4.6		V
2	Storage Temperature Range	T_stg	-40~+85			°C
6. Recommended Operating Conditions						
	Item	Symbol	min.	typ.	max.	unit
1	Supply Voltage	V <sub>CC</sub>	+1.71	+1.8	+1.89	V
			+2.09	+2.2	+2.31	
			+2.66	+2.8	+2.94	
2	Load Impedance (resistance part)	L <sub>OAD</sub> R	9	10	11	kΩ
	(parallel capacitance)	L <sub>OAD</sub> C	9	10	11	pF
3	Operating Temperature Range	T <sub>OPR</sub>	-40	-	+85	°C

## 7. Electrical Characteristics

 $(T_A=-40 \sim +85^{\circ}C, L_{OAD}R/C=10k\Omega//10pF, V_{CC}=+1.8V \text{ or } +2.2V \text{ or } +2.8V, \text{ unless otherwise noted})$ 

	ltere	Conditions		Limits		Nataa	
	Item	Conditions	min.	typ	max.	unit	Notes
1	Current Consumption		-	-	1.5	mA	
2	Output Level		0.8	-	-	V <sub>P-P</sub>	1
3	Symmetry	GND level (DC cut)	40/60	-	60/40	%	
4	Frequency Stability						
	1.Tolerance	After 2 times reflow	-	-	±1.5	ppm	2,3
	2.vs Temperature	T <sub>A</sub> =-30~+85°C	-	-	±0.5	ppm	4
		T <sub>A</sub> =-40~-30°C	-	-	±1.0	ppm	4
	3.vs Drift Rate/Slope	@ 0.3°C/s			±10.0	ppb/s	
	4.vs Hysteresys		-	-	±0.6	ppm	
	5.vs Supply Voltage	V <sub>CC</sub> =+1.8V±5%,+2.2V±5%,+2.8V±5%	-	-	±0.1	ppm	
	6.vs Load Variation	$L_{OAD} R//C = (10 k \Omega / / 10 pF) \pm 10\%$	-	-	±0.1	ppm	
	7.vs Aging	T <sub>A</sub> =Room ambient		-	±1.0	ppm/year	
		T <sub>A</sub> =Room ambient	-	-	±1.5	ppm/2years	
		T <sub>A</sub> =Room ambient	-	-	±2.5	ppm/5years	
		T <sub>A</sub> =Room ambient	-	-	±5.0	ppm/10years	
5	G Sensitivity	Gamma Vector of all 3axes from 30 to 1500Hz	-	-	±2.0	ppb/G	
6	Start Up Time	@90% of final V <sub>OUT</sub> level	-	-	2.0	ms	
7	SSB Phase Noise	Relative to f0 level offset 1Hz	-	-	-50	dBc/Hz	
		Relative to f0 level offset 5Hz	-	-	-73	dBc/Hz	
		Relative to f0 level offset 10Hz	-	-	-80	dBc/Hz	
		Relative to f0 level offset 100Hz	-	-	-106	dBc/Hz	
		Relative to f0 level offset 1kHz	-	_	-134	dBc/Hz	
		Relative to f0 level offset 10kHz	-	-	-144	dBc/Hz	
		Relative to f0 level offset 100kHz	-	-	-152	dBc/Hz	

Notes

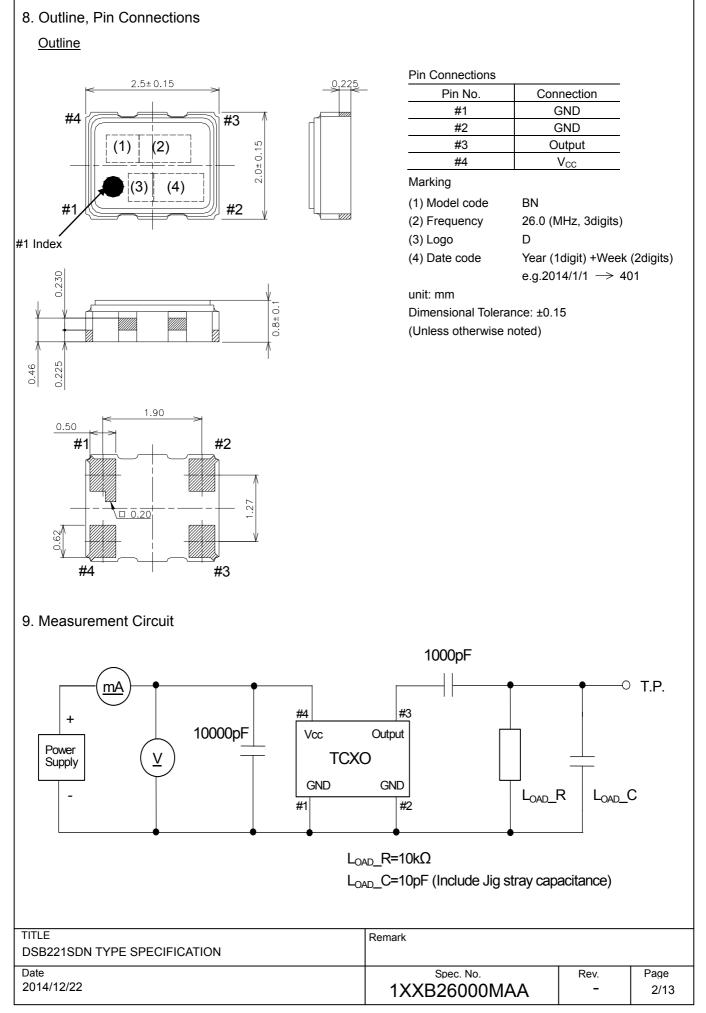
1. Clipped sine wave (DC-coupled)

2. Ref. to nominal frequency

3. Please leave after reflow in 2h or more at room ambient.

4. Ref. to frequency  $(T_A=+25^{\circ}C)$ 

TITLE	Remark		
DSB221SDN TYPE SPECIFICATION			
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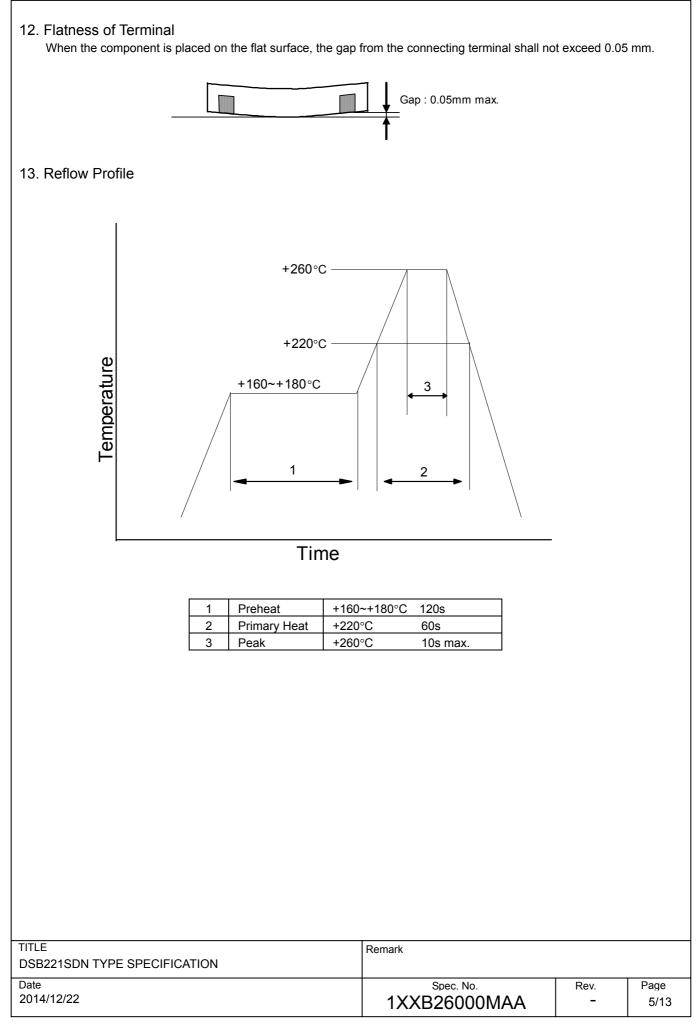


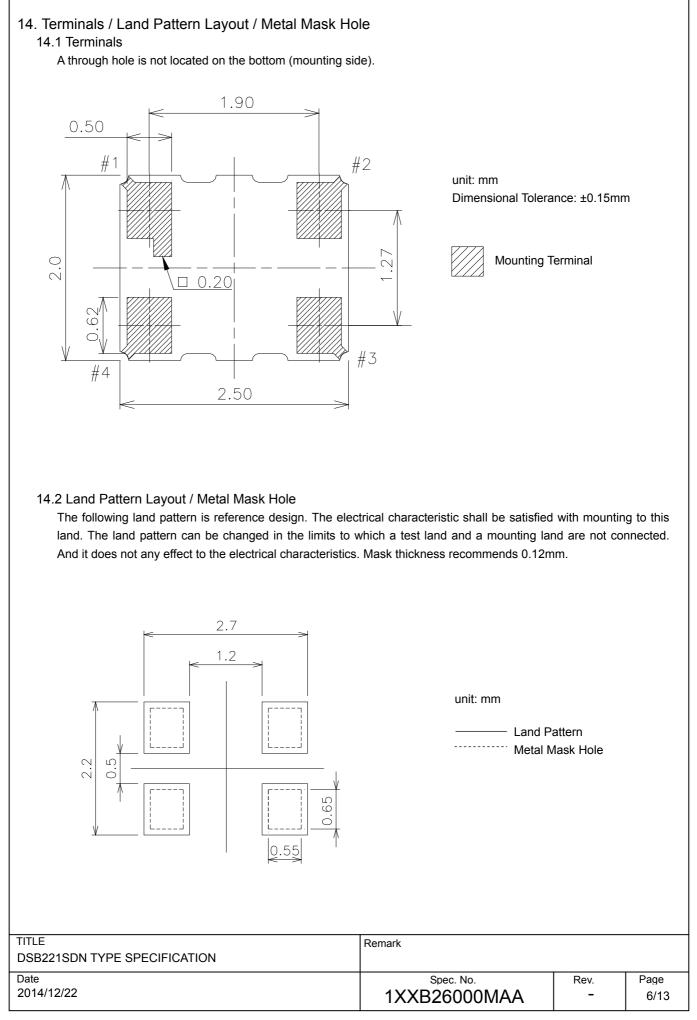
	1	I test is performed after 3times reflow (Cla	ause. 15) except 1			ig nee	
1	Item	Description		Re	quirements		
1	Drop	Natural drop (On concrete)					
		Mounting on the set or test fixture.(Tota	weight 100g)				
		Height : 150cm		df/f=<±1.0ppm			
		Direction : X,Y,Z, 6directions			-		
		Test cycle : 3cycles					
	) (han ti a a	Reference specification : EIAJ-ED-4702	A Method5				
2	Vibration	Sweep range : 10~500Hz					
		Sweep speed : 11min/cycle					
		Amplitude : 1.5mm (10~55Hz)					
		Acceleration : 200m/s <sup>2</sup> (55~500Hz)		df/f=<±0.5ppm			
		Direction : X,Y,Z, 3directions					
		Test cycle : 10cycles					
		Reference specification : IEC 60068-2-6	)				
3	Shock	Acceleration : 1000m/s <sup>2</sup>					
		Direction : X,Y,Z, 6directions					
		Duration : 6ms	df/f=<±0.5ppm				
		est cycle : 3cycles/each directions					
		Reference specification : IEC 60068-2-2	27				
4	PCB bend		PWB : t=1.6mm				
	strength	Pressure speed : 1.0mm/s	df/f=<±0.5ppm				
		Bend width : 1→2→3mm	No visible damage.				
		Duration : 10±1s No leak damage.					
		Reference specification : IEC 60068-2-2	21 Ue1				
5	Adherence nature	PWB : t=1.6mm					
		Direction : X,Y, 2directions	df/f=<±0.5ppm				
		Pressure : 10N		No visible damage.			
		Duration : 10±1s		No leak dar	nage.		
		Reference specification : IEC 60068-2-2	21 Ue3				
6	Package strength	Pressure : 10N	df/f=<±0.5ppm				
		Duration : 10±1s	No mechanical damage.				
		Reference specification : IEC 60068-2-7	7	No leak damage.			
7	Gross leak	It is immersed for 3min into +125±5°C					
		Chlorofluorocarbon (CFCs) liquid.	No continuous air bubbles.		S.		
		Reference specification : IEC 60068-2-7	17				
8	Fine leak	It shall be measured by the helium leak	detector				
		after pressurization for 60min by the pre					
		of (3.92±0.49) x10 <sup>5</sup> Pa in a helium gas a	Less than 1.0x10 <sup>-9</sup> Pa m <sup>3</sup> /s.				
		Reference specification : IEC 60068-2-					
9	Solderability	Solder bath temperature : +245±5°C		A new unifo	rm coating of	solde	
		Duration : 3±0.3s			a minimum of		
		Reference specification : IEC 60068-2-5	58	of the surfa	ce being imme	rsed.	
10	Resistance to	1) Solder iron method			<b>J</b>		
	soldering heat	Bit size : $B(\phi 3)$ Bit temperature : +350	+10°C	df/f=<±0.5ppm			
	control in gridest	Duration : $3+1/-0s$ /each terminal		dV <sub>OUT</sub> =<±0.	-		
		It shall be measured after 2h at room te	mperature	No visible d			
		humidity. Reference specification : IEC	•		amage.		
		2) Reflow	00000 2 20				
		In refer to temperature profile shown in	clause13	df/f=<±1.0p	nm		
		Test cycle : 3cycles		$dV_{OUT} = <\pm 0.$			
		It shall be measured after 2h at room te	mporaturo	No visible d			
		humidity. Reference specification : IEC			anaye.		
			00000-2-00				
LE		Rem	ark				
SB2	221SDN TYPE SPECIF	ICATION					
ite			Spec. No.		Rev.	Pa	
	/12/22		1XXB2600			i '	

### 11. Environmental Characteristics

2   3	Item Low temperature storage High temperature storage Humidity	DescriptionTemperature : -40±3°CDuration : 1000hIt shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-1 AbTemperature : +85±2°CDuration : 1000hIt shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 BbTemperature : +85±2°CDuration : 1000hIt shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 BbTemperature : +85±2°CR.H. 85±5%Duration : 1000hIt shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-3	$\label{eq:constraint} \begin{array}{ c c c } \hline Requirements \\ \hline df/f=<\pm 1.0ppm \\ dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ are satisfied. \\ \hline df/f=<\pm 1.0ppm \\ dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ are satisfied. \\ \hline df/f=<\pm 1.0ppm \\ dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline The electrical characteristics \\ \hline dV_{OUT}=<\pm 0.2V_{P-P} \\ \hline dV_{OUT}=<\pm 0.2V_{P-P}$
2   3	storage High temperature storage Humidity	Duration : 1000h It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-1 Ab Temperature : +85±2°C Duration : 1000h It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	$dV_{OUT} = <\pm 0.2V_{P-P}$ The electrical characteristics are satisfied. $df/f = <\pm 1.0ppm$ $dV_{OUT} = <\pm 0.2V_{P-P}$ The electrical characteristics are satisfied. $df/f = <\pm 1.0ppm$ $dV_{OUT} = <\pm 0.2V_{P-P}$ The electrical characteristics
2   5 3	High temperature storage Humidity	It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-1 Ab Temperature : +85±2°C Duration : 1000h It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	The electrical characteristics are satisfied. $df/f=<\pm 1.0ppm$ $dV_{OUT}=<\pm 0.2V_{P-P}$ The electrical characteristics are satisfied. $df/f=<\pm 1.0ppm$ $dV_{OUT}=<\pm 0.2V_{P-P}$ The electrical characteristics
3	storage	humidity. Reference specification : IEC 60068-2-1 Ab Temperature : +85±2°C Duration : 1000h It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	are satisfied. $df/f=<\pm 1.0ppm$ $dV_{OUT}=<\pm 0.2V_{P-P}$ The electrical characteristics are satisfied. $df/f=<\pm 1.0ppm$ $dV_{OUT}=<\pm 0.2V_{P-P}$ The electrical characteristics
3	storage	Temperature : +85±2°C Duration : 1000h It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	$df/f=<\pm 1.0 ppm$ $dV_{OUT}=<\pm 0.2 V_{P-P}$ The electrical characteristics are satisfied. $df/f=<\pm 1.0 ppm$ $dV_{OUT}=<\pm 0.2 V_{P-P}$ The electrical characteristics
3	storage	Duration : 1000h It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	$\label{eq:VOUT} \begin{split} dV_{OUT} = & < \pm 0.2 V_{P-P} \\ The electrical characteristics \\ are satisfied. \\ df/f = & < \pm 1.0 ppm \\ dV_{OUT} = & < \pm 0.2 V_{P-P} \\ The electrical characteristics \end{split}$
3	Humidity	It shall be measured after 2h at room temperature, humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	The electrical characteristics are satisfied. $df/f=<\pm 1.0ppm$ $dV_{OUT}=<\pm 0.2V_{P-P}$ The electrical characteristics
	·	humidity. Reference specification : IEC 60068-2-2 Bb Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	are satisfied. df/f=<±1.0ppm dV <sub>OUT</sub> =<±0.2V <sub>P-P</sub> The electrical characteristics
	·	Temperature : +85±2°C R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	df/f=<±1.0ppm dV <sub>OUT</sub> =<±0.2V <sub>P-P</sub> The electrical characteristics
	·	R.H. 85±5% Duration : 1000h It shall be measured after 2h at room temperature,	dV <sub>OUT</sub> =<±0.2V <sub>P-P</sub> The electrical characteristics
4	НТВ	Duration : 1000h It shall be measured after 2h at room temperature,	dV <sub>OUT</sub> =<±0.2V <sub>P-P</sub> The electrical characteristics
4 1	НТВ	It shall be measured after 2h at room temperature,	The electrical characteristics
4 1	НТВ		
4 I	НТВ	humidity Reference specification : IEC 60068-2-3	are satisfied.
4	НТВ		
	· -	Temperature : +85±2°C	df/f=<±1.0ppm
		Duration : 1000h	$dV_{OUT} = <\pm 0.2V_{P-P}$
		BIAS : Max value of supply voltage	
		It shall be measured after 2h at room temperature,	The electrical characteristics
		humidity. Reference specification : IEC 60068-2-2 Bb	are satisfied.
5	ТНВ	Temperature : +40±2°C	
		R.H. 90~95%	df/f=<±1.0ppm
		Duration : 1000h	dV <sub>OUT</sub> =<±0.2V <sub>P-P</sub>
		BIAS : Max value of supply voltage	The electrical characteristics
		It shall be measured after 2h at room temperature,	are satisfied.
		humidity. Reference specification : IEC 60068-2-3	
6 -	Thermal shock	Thermal shock : $-40\pm3^{\circ}$ C : 0.5h $\Leftrightarrow$ +85±2°C : 0.5h	
			df/f=<±1.0ppm
		Test cycle : 200cycles	$dV_{OUT} = \le 0.2V_{P-P}$
		Shift time : 2~3min	The electrical characteristics
		It shall be measured after 2h at room temperature,	are satisfied.
		humidity. Reference specification : IEC pub.68-2-14.Na	
7 [	ESD	Model : Machine Model (MM)	
		V=±200V (C1=200pF, R1=0Ω)	df/f=<±1.0ppm
		Number of times : 3times	dV <sub>OUT</sub> =<±0.2V <sub>P-P</sub>
		Each terminal except common terminal.	The electrical characteristics
		(Connect to test terminal)	are satisfied.
		Reference specification : EIA/JESD22-A114	
		Model : Human Body Model (HBM)	
		V=±1500V (C1=100pF, R1=1500Ω)	df/f=<±1.0ppm
		Number of times : 3times	$dV_{OUT} = < \pm 0.2V_{P-P}$
		Each terminal except common terminal.	The electrical characteristics
		(Connect to test terminal)	are satisfied.
		Reference specification : EIA/JESD22-A115	

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## 15. Packing Condition

- 15.1 Taping package
  - (1) Emboss tape format and dimensions See Fig.1
  - (2) Quantity on reel 2000pcs. max. / reel
  - (3) Taping specification
  - See Fig.2
  - No lack of a product. (4) Reel specification
  - 4) Reel specif See Fig.3
  - (5) Taping material list See right table.

## 15.2 Packing

- The products packed in the antistatic bag.
- \*Moisture sensitivity level : IPC/JEDEC Standard J-STD-033 / Level 1
- No dry pack required and baking after re-storage is unnecessary.

#### 15.3 Packing box

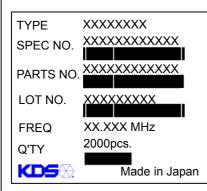
Max 10 reels/packing box. However, in the case of less than 10 reels, It is contained by any boxes. The space in a box is fill up with a cushion.

#### 15.4 Label detail

A Lot label is put on a reel and a shipping label and Pb-Free label is put on a packing box.

Lot label		<u>S</u>	hipping label		Pb-free Label
TYPE SPEC NO. PARTS NO. LOT NO. FREQ.	(Model Name) (Spec. Number) (User's Parts Number) (Lot Number) (Nominal Frequency)	2 [ (	TEM SPEC DELIVERY DATE Q'TY NOTES	(Model Name) (Spec. Number) (Delivery Date) (Quantity) (User's Parts Number)	Pb
Q'TY KDS	(Quantity) DAISHINKU CORP.		DAISHINKU CORP	( , , , , , , , , , , , , , , , , , , ,	Pb-free

### Lot label (Example)



## Formation of a lot number

e.g. AH4101001			
<u> </u>	<u>_H_</u>	4101	001
Manufacturing site code	Product code	year/ month/ day	Serial No.

Taping material List

Emboss : PS (Conductivity)

Reel : PS (Conductivity)

Cover Tape : PET + Olefin Resin (Conductivity)

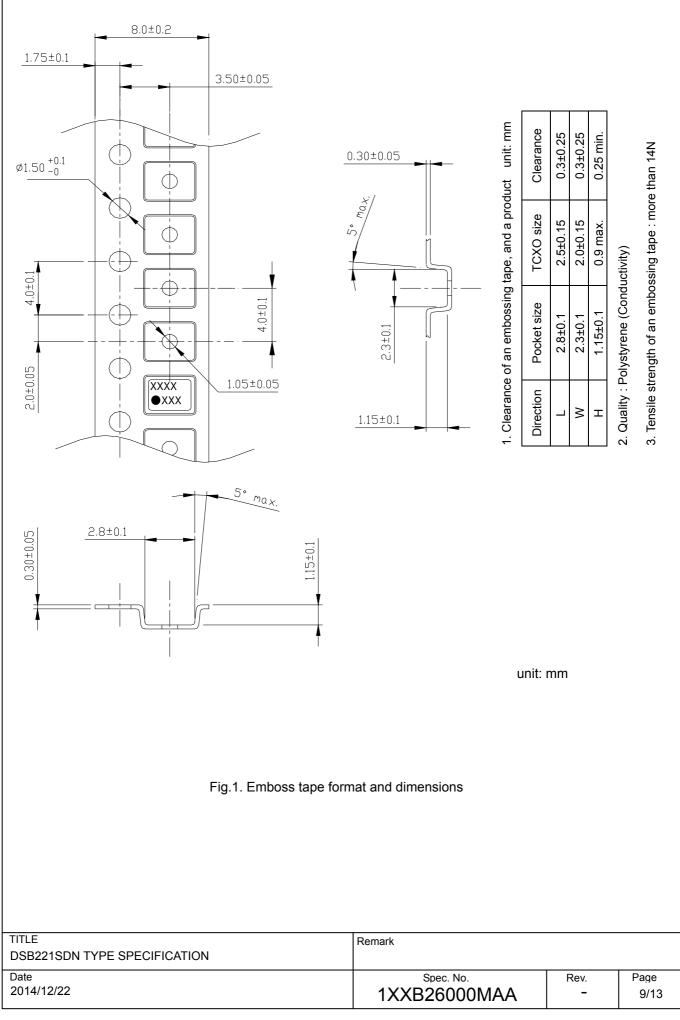
The notation method of a manufacture year, month, and day. (4digits alphanumeric character)

YMDD		(4 digits) e.g.) $2014 / 01 / 01 \rightarrow 4101$										
<u>Y</u>			Year	1	digit (l	_ast di	git of <b>\</b>	(ear)				
<u>M</u>			Month	า 1	1digit alphanumeric symbol							
<u>DD</u> Day			2	digits	numer	ical ch	aracte	ers of d	lay			
Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Symbol	1	2	3	4	5	6	7	8	9	0	Ν	D

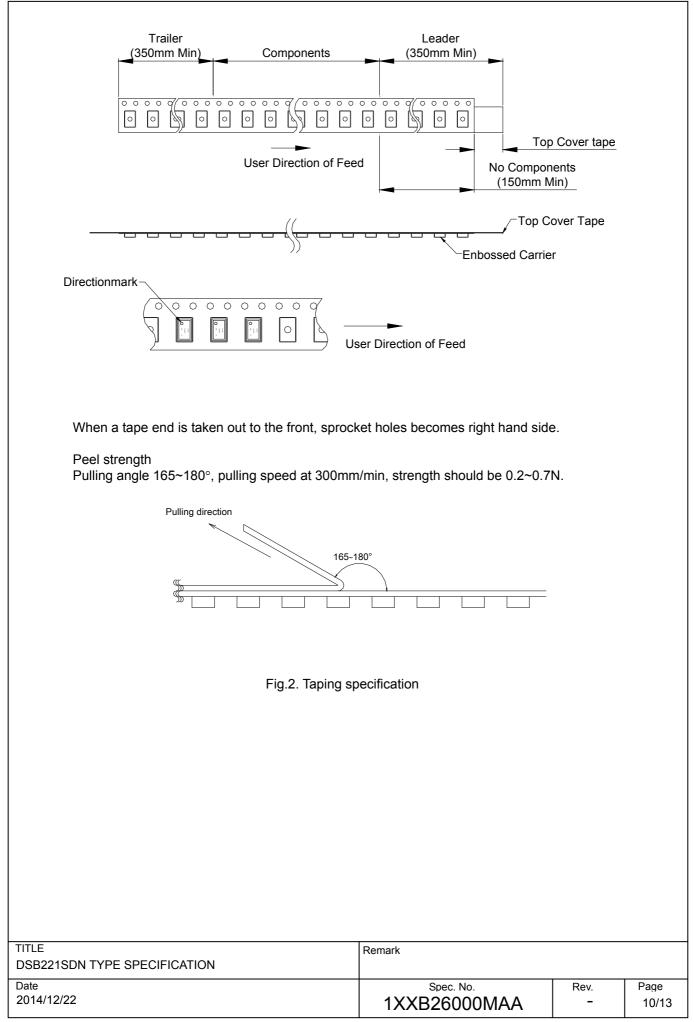
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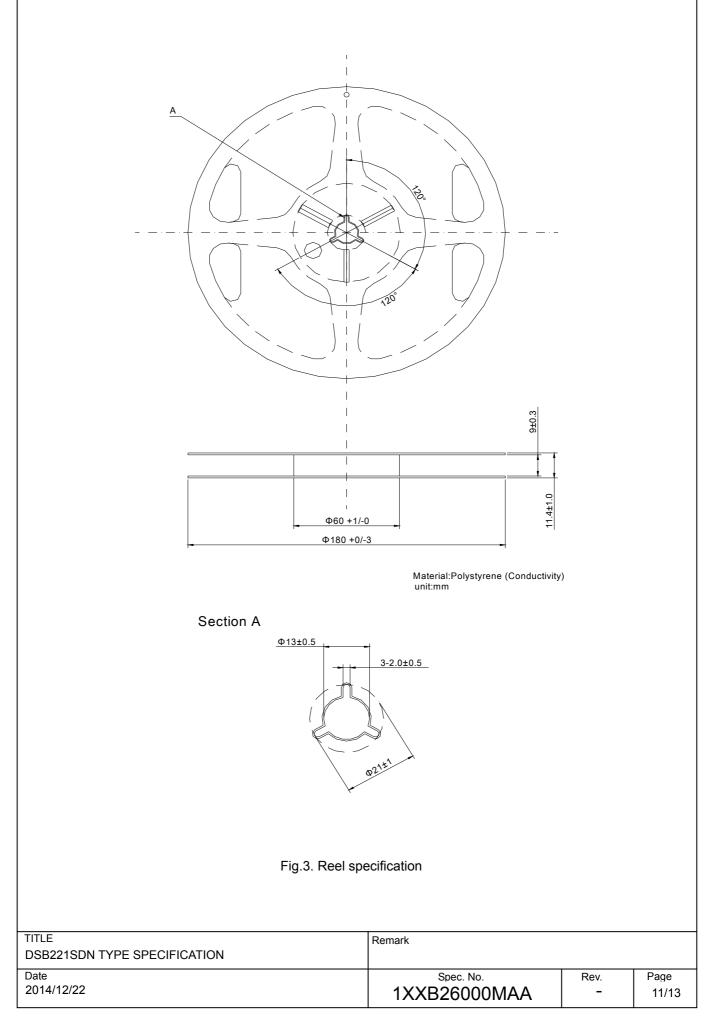
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Lot Label	Air Cushion		
Antistatic Bag	Pb-free Label Shipping Label		7
THE	does not break in the handling by a shippin	g agent.	
OSB221SDN TYPE SPECIFICATION		Devi	Dece
Date 2014/12/22	Spec. No. 1XXB26000MAA	Rev. –	Page 8/13



DM-Z0002: Style-010 Ver.1





#### 16. Notes on mounting and handling

#### 16.1 Storage environment

- (1) The temperature and humidity of a storage place, Please give +5~+40°C and 40~85% as a standard.
- (2) Please use this product within one year from the packing label date of issue.
- (3) Please avoid the place which generates corrosive gas, and the place with much dirt.
- (4) Please keep it in a place with little temperature change.
- Dew condensation arises owing to a rapid temperature change and solderability becomes bad.
- 16.2 Be cautions to static electricity and high voltage.
- 16.3 This product has sufficient durability to fall and vibration. However, conditions may change to the fall after mounting to a PWB, and vibration. When you should drop on a floor the PWB which mounted the product or too much shock is added. Please use after a performance check.
- 16.4 Please check that the curvature of the substrate at the time of substrate cutting does not affect product. Moreover, especially when a product is near the position of a PWB guide pin, and the position of PWB break, be careful.
- 16.5 The part concerned does not correspond to washing.
- 16.6 Please repair at +260°C in 10s with hot air or +350°C in 5s with solder Iron.

#### 17. Mandatory control

17.1 Ozone-depleting substance

It regulates by the U.S. air purifying method (November, 1990 establishment). ODS of CLASS1 and CLASS2 is not contained or used.

17.2 PBDE, PBBs

PBDE, PBBs are not contained into all the material currently used for this product.

#### 17.3 RoHS

Following material restricted by RoHS (2011/65/EU) is not included or used. Lead, mercury, cadmium, hexavalent, chromium, PBB and PBDE.

17.4 Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances

All the material currently used for this product is based on "Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances". It is a registered material.

#### 17.5 Lead

Leads, such as solder, are not used for this product. (Lead Free)

17.6 About the existence of silver and mercury use

The silver of very small quantity is contained in the conductive adhesives used for adhesion of Blank. Moreover, mercury is used. It does not get down.

#### 18. The country of origin / factory name / address

Japan
DAISHINKU Corp. Tottori Production Div.
7-3-21 Wakabadai minami, Tottori 689-1112

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## DAISHINKU CORP.

## 2014-1357 REVERSION RECORD

Rev. No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2014/12/22	-	Initial Release	A.Hishikawa	H.Takase	S.Fujihira

单击下面可查看定价,库存,交付和生命周期等信息

>>KDS(大真空)